









Description

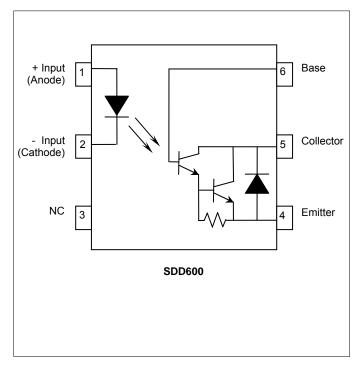
The SDD600 consists of a high voltage photo-Darlington transistor optically coupled to a light emitting diode. Optical coupling between the input IR LED and output photo-Darlington allows for high isolation levels while maintaining low-level DC signal control capability. The SDD600 provides an optically isolated method of controlling many interface applications such as telecommunications, industrial control, and instrumentation circuitry

The SDD600 comes standard in a miniature 6 pin DIP package.

Applications

- Office Automation Equipment
- System Appliances, Measuring Instruments
- Computer Terminals, PLCs
- Telecom / Datacom
- Home Appliances
- **Digital Logic Inputs**
- Fax / Modems
- **Power Supplies**

Schematic Diagram



Features

- High Load Voltage (V_{CEO} = 300V MIN)
- High Current Transfer Ration (CTR: 600-9000%)
- Low input power consumption
- High stability
- High Isolation Voltage (5000V_{RMS})
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL: File # E201932 C-UL: File # E201932 VDE: License # 40011227

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature Operating Temperature	
Continuous Input Current	
Transient Input Current	
Reverse Input Control Voltage	6V
Input Power Dissipation	40mW
Total Power Dissipation	
Solder Temperature – Wave (10sec)	
Solder Temperature – IR Reflow (10sec).	

Ordering Information

Part Number Description

SDD600 6 pin DIP, (65/Tube)

SDD600-H 0.40" (10.16mm) Lead Spacing (VDE0884)

6 pin SMD, (65/Tube) SDD600-S

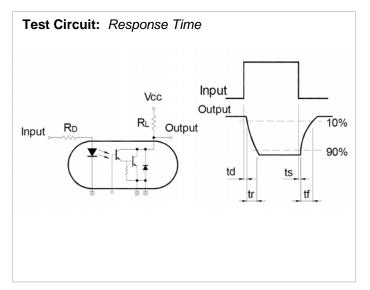
SDD600-STR 6 pin SMD, Tape and Reel (2000/Reel)

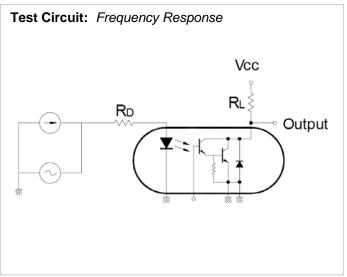
NOTE: Suffixes listed above are not included in marking on device for part number identification



Electrical Characteristics, T_A = 25°C (unless otherwise specified)

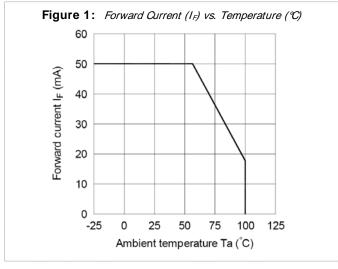
Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions		
Input Specifications								
LED Forward Voltage	V _F	-	1.2	1.4	V	I _F = 10mA		
LED Reverse Voltage	BV_R	5	-	-	V	I _R = 10μA		
Terminal Capacitance	Ct	-	30	250	pF	V=0, f=1KHz		
Reverse Current	I _R	-	-	10	μА	V _R =4V		
Output Specifications								
Collector-Emitter Voltage	V _{CEO}	300	-	-	V	I _C =10μA		
Emitter-Collector Voltage	V _{COE}	0.1	-	-	V	I _E =10μA		
Collector Dark Current	I _{CEO}	-	-	1	μА	V _{CE} =200V, I _F =0mA		
Floating Capacitance	C_{f}	-	0.6	1.0	pF	V=0, f=1MHz		
Cut-Off Frequency	f _C	1	7	-	kHz	V_{CE} =2V, I_{C} =20mA, R_{L} =100 Ω , -3dB		
Saturation Voltage	V _{CE(sat)}	-	-	1.2	V	I _F =20mA, I _C =100mA		
Coupled Specifications								
Rise Time	T_R	-	100	300	μS	I_C =20mA, V_{CC} =2V, R_L =100 Ω		
Fall Time	T _F	-	20	100	μS	I_C =20mA, V_{CC} =2V, R_L =100 Ω		
Current Transfer Ratio	CTR	1000	4000	15000	%	I _F =1mA, V _{CE} =2V		
Isolation Specifications	on Specifications							
Isolation Voltage	V _{ISO}	5000	-	-	V _{RMS}	RH ≤ 50%, t=1min		
Input-Output Resistance	R _{I-O}	-	10 ¹²	-	Ω	V _{I-O} = 500V _{DC}		

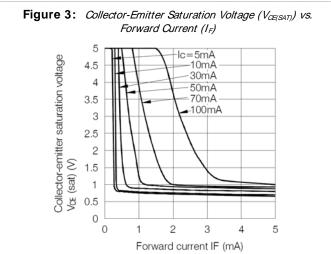


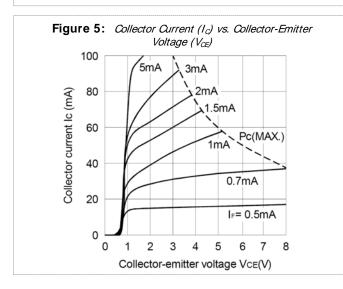


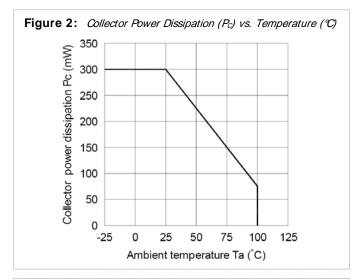


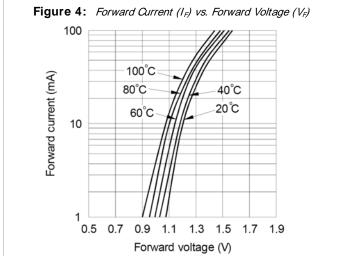
SDD600 Performance & Characteristics Plots, T_A = 25°C (unless otherwise specified)

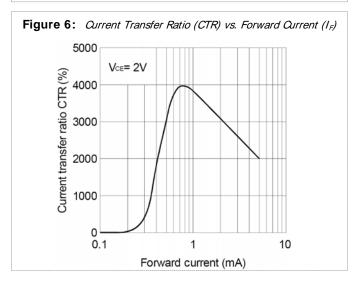






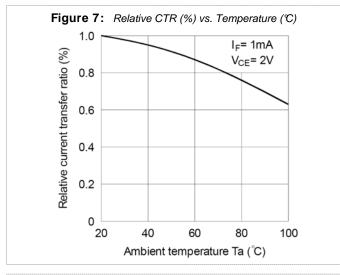


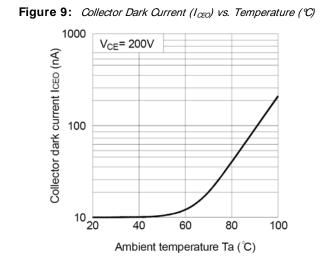


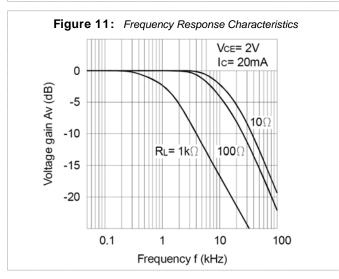


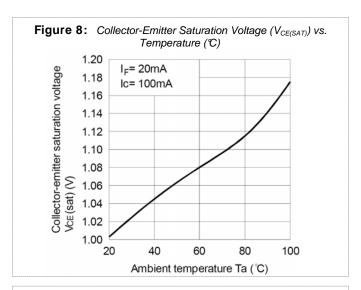


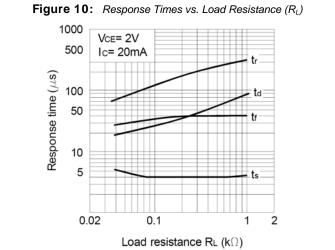
SDD600 Performance & Characteristics Plots, T_A = 25°C (unless otherwise specified)









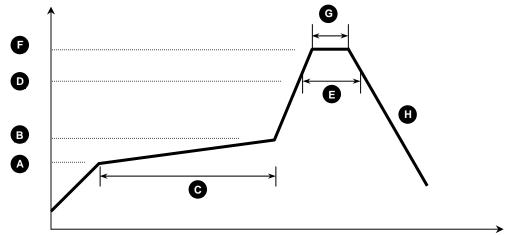




SDD600 Solder Reflow Temperature Profile Recommendations

(1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:



Process Step	Description	Parameter			
Α	Preheat Start Temperature (°C)	150°C			
В	Preheat Finish Temperature (°C)	180°C			
С	Preheat Time (s)	90 - 120s			
D	Melting Temperature (°C)	230°C			
E	Time above Melting Temperature (s)	30s			
F	Peak Temperature, at Terminal (°C)	260°C			
G	Dwell Time at Peak Temperature (s)	10s			
Н	Cool-down (°C/s)	<6°C/s			

(2) Wave Solder:

Maximum Temperature: 260°C (at terminal)

Maximum Time: 10s

Pre-heating: 100 - 150°C (30 - 90s)

Single Occurrence

(3) Hand Solder:

Maximum Temperature: 350°C (at tip of soldering iron) 3s

Maximum Time:

Single Occurrence

© 2011 Solid State Optronics • San José, CA

www.ssousa.com • +1.408.293.4600

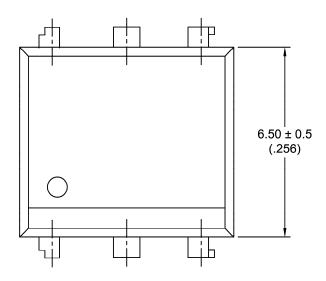
SDD600

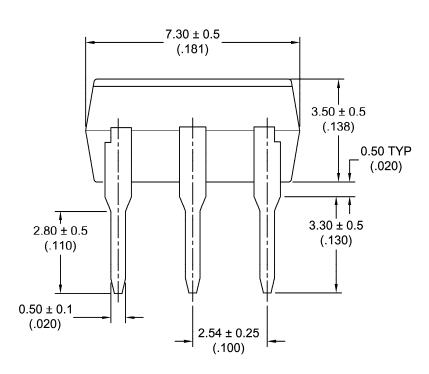


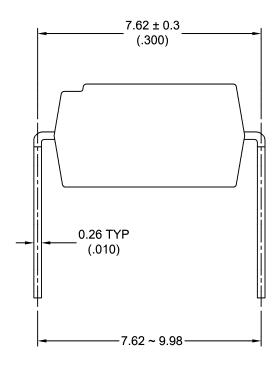
SDD600 Package Dimensions

6 PIN DIP Package

Note: All dimensions in millimeters [mm] with inches in parenthesis ()





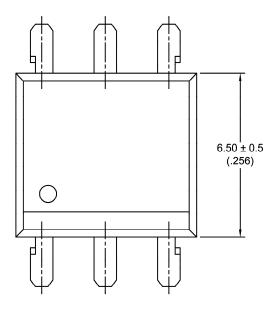


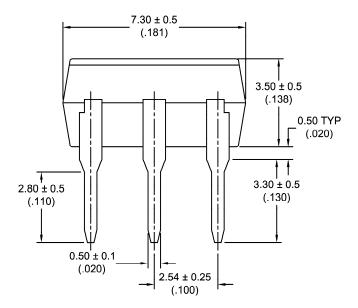


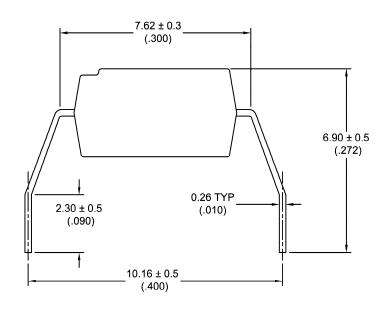
SDD600 Package Dimensions

6 PIN WIDE Lead Space Package (-H)

Note: All dimensions in millimeters [mm] with inches in parenthesis ()







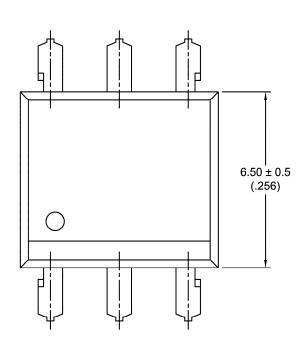
SDD600

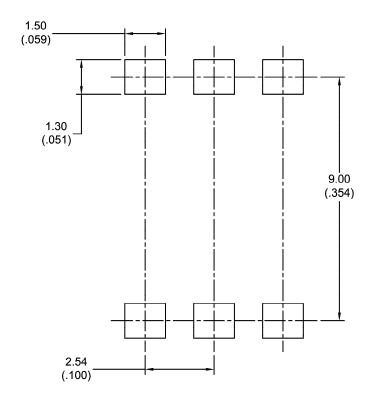


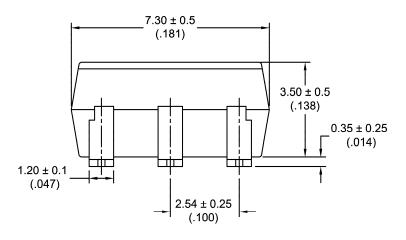
SDD600 Package Dimensions

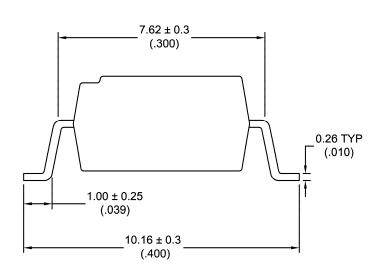
6 PIN SMD Surface Mount Package (-S)

Note: All dimensions in millimeters [mm] with inches in parenthesis ()







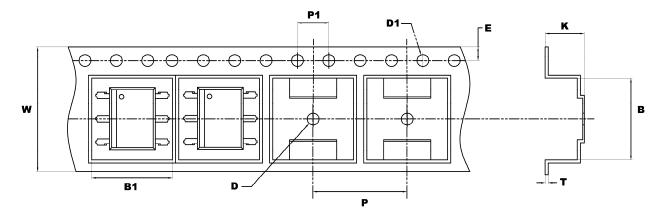




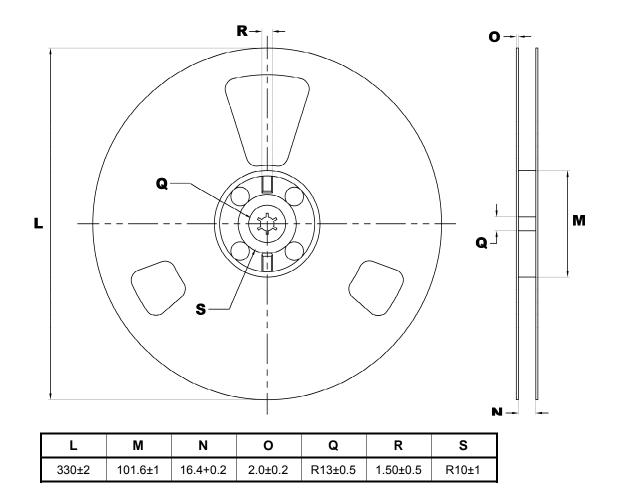
SDD600 Packaging Specifications

Tape & Reel Specifications (T&R)

Note: All dimensions in millimeters [mm]



	В	B1	D	D1	E	K	Р	P1	Т	W
ĺ	7.70±0.1	10.46±0.1	ø1.60±0.1	ø1.55±0.05	1.75±0.1	4.25±0.1	12.0±0.1	4.00±0.1	0.3±0.05	16±0.3





SDD600

DC Input 300V Photo-Darlington Optocoupler

DISCLAIMER

Solid State Optronics (SSO) makes no warranties or representations with regards to the completeness and accuracy of this document. SSO reserves the right to make changes to product description, specifications at any time without further notices.

SSO shall not assume any liability arising out of the application or use of any product or circuit described herein. Neither circuit patent licenses nor indemnity are expressed or implied.

Except as specified in SSO's Standard Terms & Conditions, SSO disclaims liability for consequential or other damage, and we make no other warranty, expressed or implied, including merchantability and fitness for particular use.

LIFE SUPPORT POLICY

SSO does not authorize use of its devices in life support applications wherein failure or malfunction of a device may lead to personal injury or death. Users of SSO devices in life support applications assume all risks of such use and agree to indemnify SSO against any and all damages resulting from such use. Life support devices are defined as devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when used properly in accordance with instructions for use can be reasonably expected to result in significant injury to the user, or (d) a critical component of a life support device or system whose failure can be reasonably expected to cause failure of the life support device or system, or to affect its safety or effectiveness.